

MOS FIELD EFFECT TRANSISTOR

NP82N055CLE,NP82N055DLE,NP82N055ELE,NP82N055KLE

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

These products are N-channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

- Channel temperature 175 degree rated
- Super low on-state resistance

 $R_{DS(on)1}=8.4~m\Omega$ MAX. (Vgs = 10 V, Ip = 41 A)

 $R_{DS(on)2} = 11 \ m\Omega \ MAX. \ (V_{GS} = 5.0 \ V, \ I_{D} = 41 \ A)$ • Low Ciss : Ciss = 4400 pF TYP.

• Built-in gate protection diode

ORDERING INFORMATION

PART NUMBER	PACKAGE
NP82N055CLE	TO-220AB
NP82N055DLE	TO-262
NP82N055ELE	TO-263 (MP-25ZJ)
NP82N055KLE	TO-263 (MP-25ZK)

(TO-220AB)



(TO-262)



(TO-263)

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vgs = 0 V)	VDSS	55	V
Gate to Source Voltage (Vps = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C) Note1	ID(DC)	±82	Α
Drain Current (Pulse) Note2	ID(pulse)	±300	Α
Total Power Dissipation (Tc = 25°C)	5°C) Pτ 163 5°C) Pτ 1.8		W
Total Power Dissipation (T _A = 25°C)	Рт	1.8	W
Channel Temperature	Tch	175	°C
Storage Temperature	Tstg	-55 to +175	°C
Single Avalanche Current Note3	las	72 / 50 / 17	Α
Single Avalanche Energy Note3	Eas	51 / 250 / 289	mJ

Notes 1. Calculated constant current according to MAX. allowable channel temperature.

2. PW \leq 10 μ s, Duty cycle \leq 1%

3. Starting T_{ch} = 25°C, V_{DD} = 28 V, R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V (see Figure 4.)



THERMAL RESISTANCE

Channel to Case Thermal Resistance Rth(ch-C) 0.92 °C/W Channel to Ambient Thermal Resistance Rth(ch-A) 83.3 °C/W

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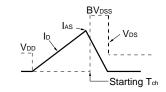
sales representative for availability and additional information.

ELECTRICAL CHARACTERISTICS (TA = 25°C)

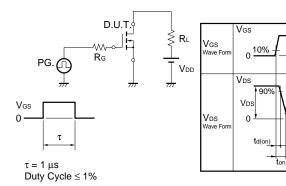
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 55 V, V _{GS} = 0 V			10	μΑ
Gate Leakage Current	Igss	Vgs = ±20 V, Vps = 0 V			±10	μΑ
Gate to Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$	1.5	2.0	2.5	V
Forward Transfer Admittance	y _{fs}	V _{DS} = 10 V, I _D = 41 A	24	50		S
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, ID = 41 A		6.7	8.4	mΩ
	RDS(on)2	Vgs = 5.0 V, ID = 41 A		7.9	11	mΩ
	RDS(on)3	Vgs = 4.5 V, ID = 41 A		8.4	12	mΩ
Input Capacitance	Ciss	V _{DS} = 25 V		4400	6600	pF
Output Capacitance	Coss	Vgs = 0 V		550	830	pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		270	490	pF
Turn-on Delay Time	td(on)	VDD = 28 V, ID = 41 A		28	61	ns
Rise Time	tr	Vgs = 10 V		16	39	ns
Turn-off Delay Time	t d(off)	$R_G = 1 \Omega$		92	180	ns
Fall Time	tf			18	45	ns
Total Gate Charge 1	Q _{G1}	ID = 82 A, VDD = 44 V, VGS = 10 V		80	120	nC
Total Gate Charge 2	Q _{G2}	V _{DD} = 44 V		45	68	nC
Gate to Source Charge	Qgs	Ves = 5.0 V		15		nC
Gate to Drain Charge	Q _{GD}	ID = 82 A		24		nC
Body Diode Forward Voltage	V _F (S-D)	IF = 82 A, VGS = 0 V		1.0		٧
Reverse Recovery Time	trr	IF = 82 A, Vgs = 0 V		47		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		66		nC

TEST CIRCUIT 1 AVALANCHE CAPABILITY

$V_{GS} = 20 \rightarrow 0 \text{ V}$ $V_{GS} = 20 \rightarrow 0 \text{ V}$



TEST CIRCUIT 2 SWITCHING TIME



90%

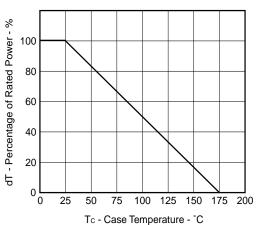
90%

TEST CIRCUIT 3 GATE CHARGE

175

TYPICAL CHARACTERISTICS (TA = 25°C)

Figure 1. DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



P_T - Total Power Dissipation - W 150 125 100 75 50 25 0 0 25 50 75 100 125 175 150 Tc - Case Temperature - °C

Figure 2. TOTAL POWER DISSIPATION vs.

CASE TEMPERATURE

Figure.3 FORWARD BIAS SAFE OPERATING AREA

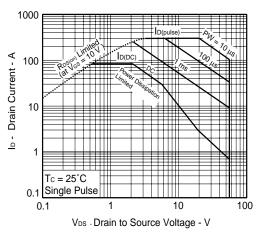


Figure 4. SINGLE AVALANCHE ENERGY DERATING FACTOR

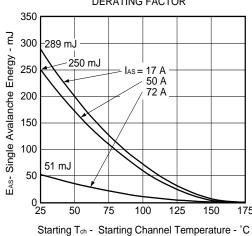
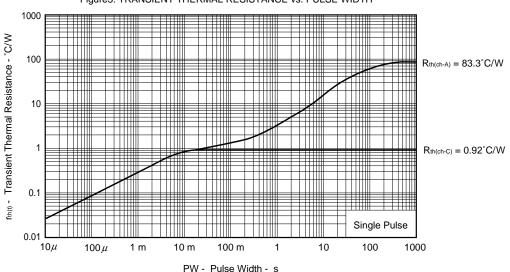


Figure 5. TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH





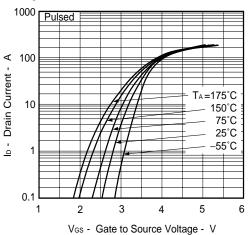


Figure 8. FORWARD TRANSFER ADMITTANCE vs.

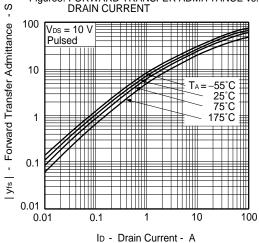


Figure 10. DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

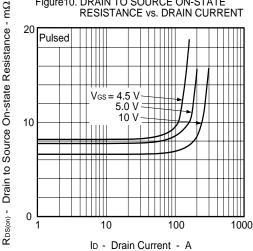
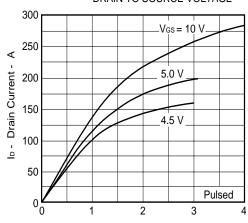


Figure 7. DRAIN CURRENT vs.
DRAIN TO SOURCE VOLTAGE



VDS - Drain to Source Voltage - V

Figure9. DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

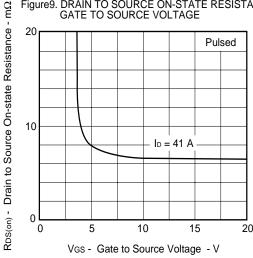
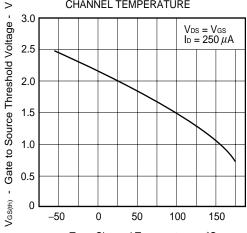
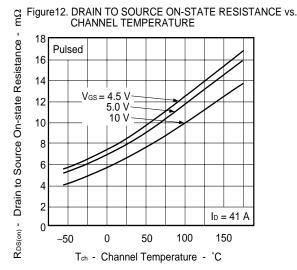


Figure 11. GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE



Tch - Channel Temperature - °C





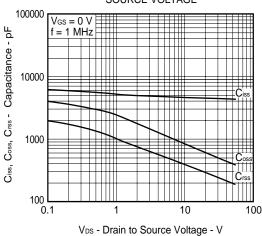


Figure16. REVERSE RECOVERY TIME vs. DRAIN CURRENT

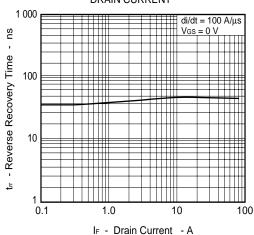


Figure 13. SOURCE TO DRAIN DIODE FORWARD VOLTAGE

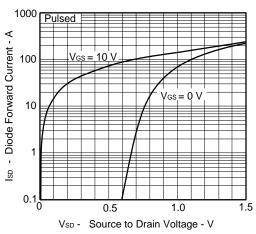


Figure 15. SWITCHING CHARACTERISTICS

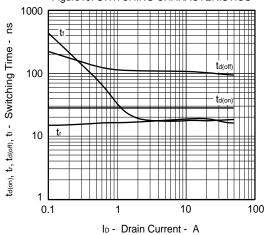
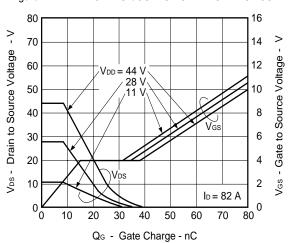
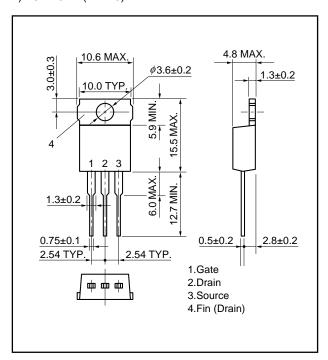


Figure 17. DYNAMIC INPUT/OUTPUT CHARACTERISTICS

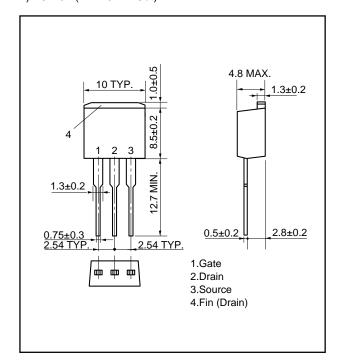


PACKAGE DRAWINGS (Unit: mm)

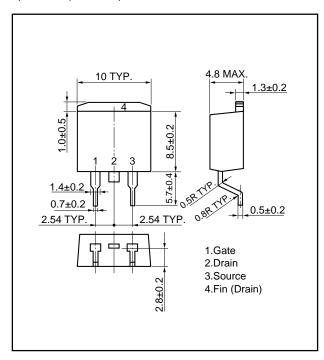
1) TO-220AB (MP-25)



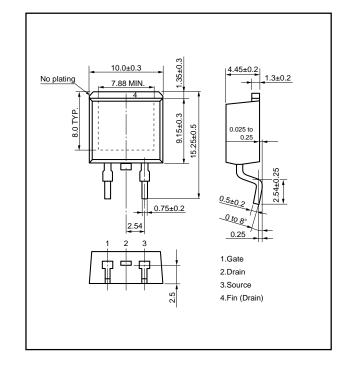
2) TO-262 (MP-25 Fin Cut)



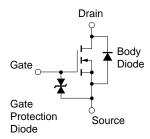
3) TO-263 (MP-25ZJ)



★ 4) TO-263 (MP-25ZK)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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